■ Lighting Color

• Blue

LNJ953W8CRA

Hight Bright Surface Mounting Chip LED

SV (Side View) -0.5 Type

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit		
Power dissipation	P_{D}	55	mW		
Forward current	I_{F}	15	mA		
Pulse forward current *	I_{FP}	70	mA		
Reverse voltage	V _R	5	V		
Operating ambient temperature	T _{opr}	-30 to +85	°C		
Storage temperature	T _{stg}	-40 to +100	°C		

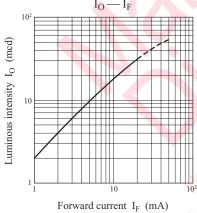
Note) *: The condition of I_{FP} is duty 10%, Pulse width 1 msec.

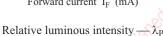
■ Electro-Optical Characteristics $T_a = 25$ °C±3°C

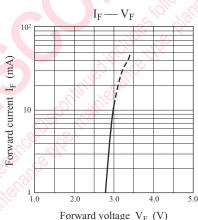
a a						
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Luminous intensity *1	I _O	$I_F = 5 \text{ mA}$	7.0	10.0	34.7	mcd
Reverse current	I_R	$V_R = 5 V$		CHON	100	μΑ
Forward voltage	V _F	$I_F = 5 \text{ mA}$	111	2.9	3.2	V
Peak emission wavelength	$\lambda_{ m P}$	$I_F = 5 \text{ mA}$	4110	465		nm
Dominant emission wavelength *2	λ_{d}	$I_F = 5 \text{ mA}$	462	470	478	nm
Spectral half band width	Δλ	$I_F = 5 \text{ mA}$	dilli	20		nm

Note) *1: Measurement tolerance: ±20%

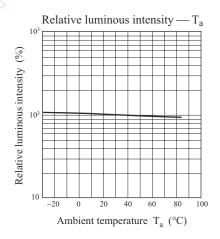
^{*2:} Measurement tolerance: ±3 nm



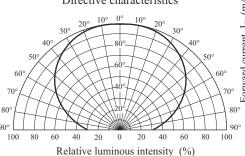


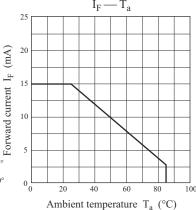


Forward voltage V_F (V)





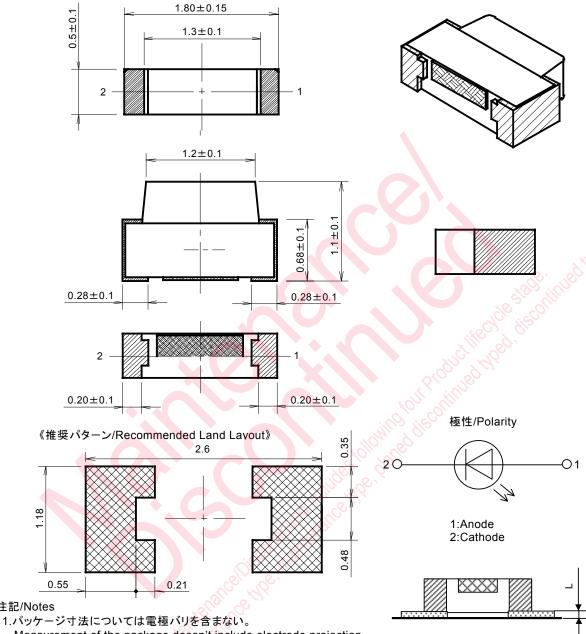






Relative luminous intensity (%)

■ Package (Unit: mm)



- Measurement of the package doesn't include electrode projection.
- 2.当製品は工法上、はんだ付け面端子端部にメッキバリカエリが発生することや、製品背面部に端子を有する縦型面 実装タイプである為、リフローはんだ付けの際に不濡れ等が懸念されます。従いまして、はんだの種類の検討ならび に各パットに対し、適正なはんだ量を考慮してください。

Precaution to soldering

Assembly conditions such like mechanical lode in placing LED and also suitable volume and type of solder paste has to be fully investigated.

Insufficient soldering may occur because of the condition of solder terminal surface which is caused is caused by its unique production process.

3.基本的に LED 直下範囲には固着フットパターン厚み(L)以上のシルク印刷をしないでください。 Please do not print silk more than fixture foot pattern thickness (L) basically within the range right under the LED.

Ver. DEK 2

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